

MC2681P Information

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General Information

Parameter	Value
Part Number	MC2681P
Description	END OF LIFE
PTI	JBTI
Material Type	Tested Packaged Device
Life Cycle Description (code)	REMOVED FROM ACTIVE PORTFOLIO
Status	No Longer Manufactured

Package Information

Parameter	Value
Package Length (nominal)(mm)	52.070
Package Width (nominal)(mm)	13.970
Package Thickness (nominal)(mm)	7.680
Tape & Reel	No

Environmental and Compliance Information

Parameter	Value
Pb-Free	Not Available
RoHS Compliant	Not Available
Material Composition Declaration (MCD)	Contact Us
RoHS Certificate of Analysis (CoA)	Contact Us
Peak Package Body Temperature (PPT)(°C)	Not Available
REACH SVHC	Freescale REACH Statement

Ordering Information

Parameter	Value
Exempt from Minimum Delivery Value	Yes
Export Control Classification Number (US)	EAR99
Harmonized Tariff (US) Disclaimer	8542.21.8089
CCATS Document	-
ENC Status	-
Other Trade Compliance Documents	-
Budgetary Price excluding tax(US\$) Change Currency	-
Order	

Product/Process Change Notice (PCN)

Number	Type	Title	Issue Date	Effectivity Date
3591	Product Change Notice	PACKAGE TRANSFER OF 28 AND 40LD PDIP PACKAGES FROM KLM TO TJN	12 Jun 1998	20 Sep 1998
3218	Product Change Notice	INTRODUCTION OF NEW MOLD COMPOUND, HAREUS 1.0 MIL GOLD WIRE AND DIE ATTACH EPOXY FOR 40LD PDIP ASSEMBLY LINE IN TIANJIN	05 Mar 1998	15 Jun 1998
2674	Product Change Notice	CONVERSION TO 6" WAFERS IN MOS 3	29 May 1997	15 Sep 1997
2628	Product Discontinuance	68681/2681 END-OF-LIFE ANNOUNCEMENT	18 Mar 1997	18 Mar 1997
2519	Product Discontinuance	68681/2681 END-OF-LIFE ANNOUNCEMENT	28 Feb 1997	28 Feb 1997

Operating Characteristics

Parameter	Value
Sample Exception Availability	N